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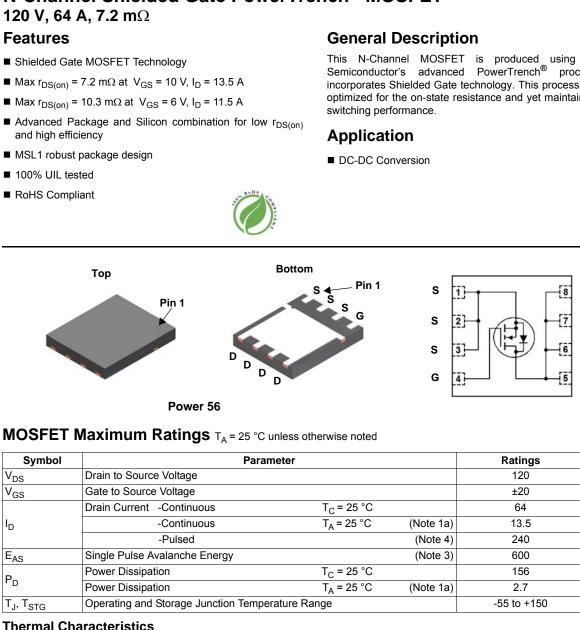


ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		0.8	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	45	0/10

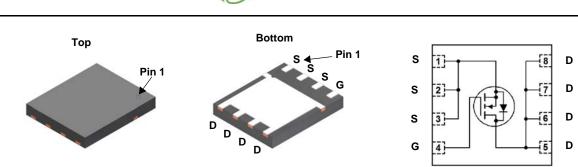
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86202	FDMS86202	Power 56	13 "	12 mm	3000 units

July 2014

FAIRCHILD **FDMS86202**

N-Channel Shielded Gate PowerTrench[®] MOSFET

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench $^{\textcircled{B}}$ process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior



Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			120	V
V _{GS}	Gate to Source Voltage			±20	V
	Drain Current -Continuous	T _C = 25 °C		64	
I _D	-Continuous	T _A = 25 °C	(Note 1a)	13.5	Α
	-Pulsed		(Note 4)	240	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	600	mJ
D	Power Dissipation	T _C = 25 °C		156	w
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.7	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C
Thermal Ch	naracteristics				

Package Marking and Ordering Information

1

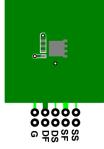
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	120			V
ΔΒV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		103		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 96 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	3.1	4.0	V
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		-10		mV/°0
		V _{GS} = 10 V, I _D = 13.5 A		6.0	7.2	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 11.5 A		8.1	10.3	mΩ
. ,		V_{GS} = 10 V, I _D = 13.5 A,T _J = 125 °C		10.9	13.2	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 13.5 A		44		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			3195	4250	pF
C _{oss}	Output Capacitance	— V _{DS} = 60 V, V _{GS} = 0 V, — f = 1 MHz		449	600	pF
C _{rss}	Reverse Transfer Capacitance			17	30	pF
R _g	Gate Resistance		0.1	0.9	2.7	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			21	33	ns
t _r	Rise Time	V _{DD} = 60 V, I _D = 13.5 A,		6	13	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10 V, R _{GEN} = 6 Ω		27	44	ns
t _f	Fall Time			5	11	ns
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		45	64	nC
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V V_{DD} = 60 V,$		29	41	nC
Q _{gs}	Gate to Source Charge	I _D = 13.5 A		14.3		nC
Q _{gd}	Gate to Drain "Miller" Charge			8.7	1	nC

Drain-Source Diode Characteristics

V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 2.1 A (Note 2) 0.69	1.2	V
	Source to Drain Diode Torward Voltage	V _{GS} = 0 V, I _S = 13.5 A (Note 2) 0.76	1.3	v
t _{rr}	Reverse Recovery Time	I _F = 13.5 A, di/dt = 100 A/μs	73	118	ns
Q _{rr}	Reverse Recovery Charge	$F = 13.3 \text{ A}, \text{ u/ut} = 100 \text{ A/} \mu \text{s}$	117	187	nC

Notes:

1. R_{0,JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0,JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

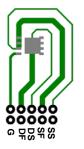


2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

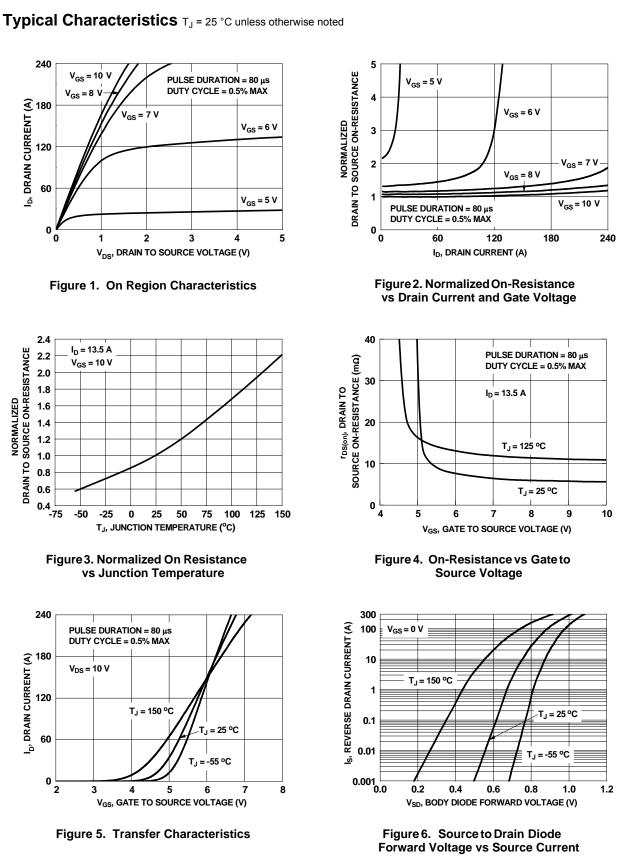
a) 45 °C/W when mounted on a 1 in² pad of 2 oz copper

3. E_{AS} of 600 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 20 A, V_{DD} = 120 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 65 A.

4. Pulse Id limited by junction temperature, td ≤ 100 μ s, please refer to SOA curve for more details.

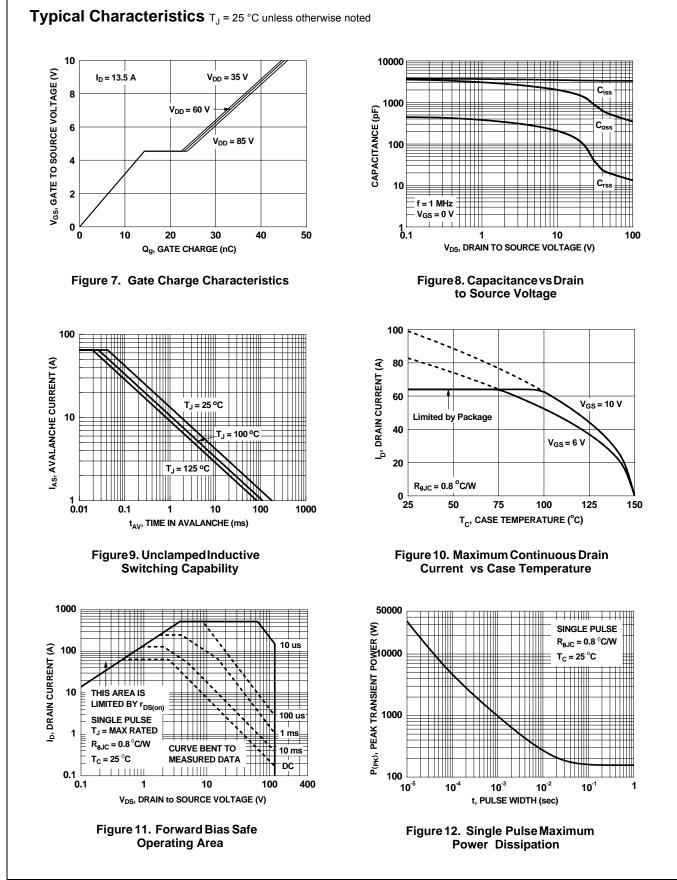


b) 115 °C/W when mounted on a minimum pad of 2 oz copper.

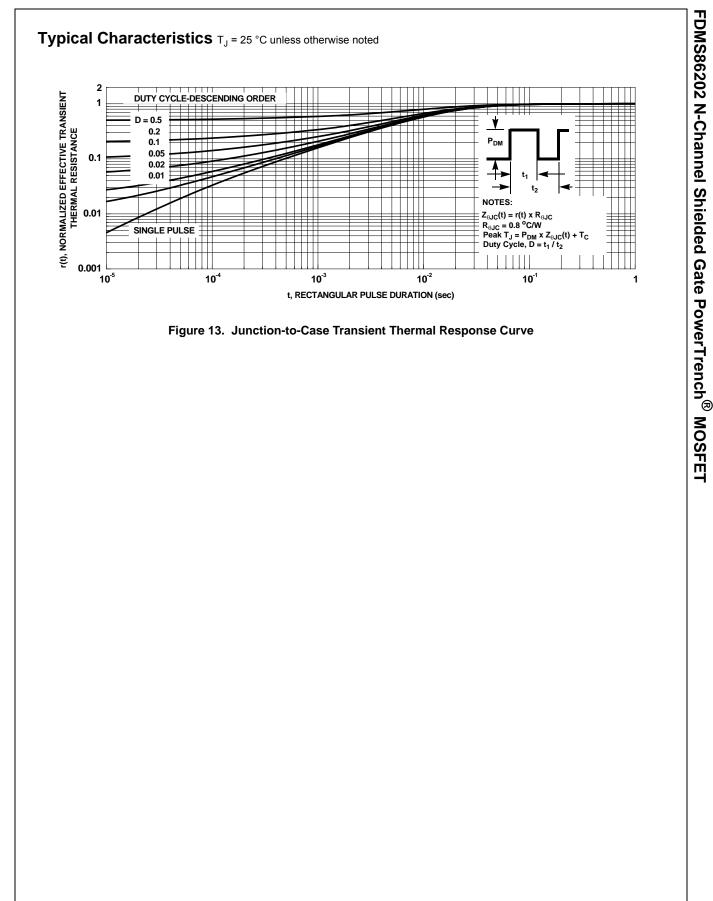


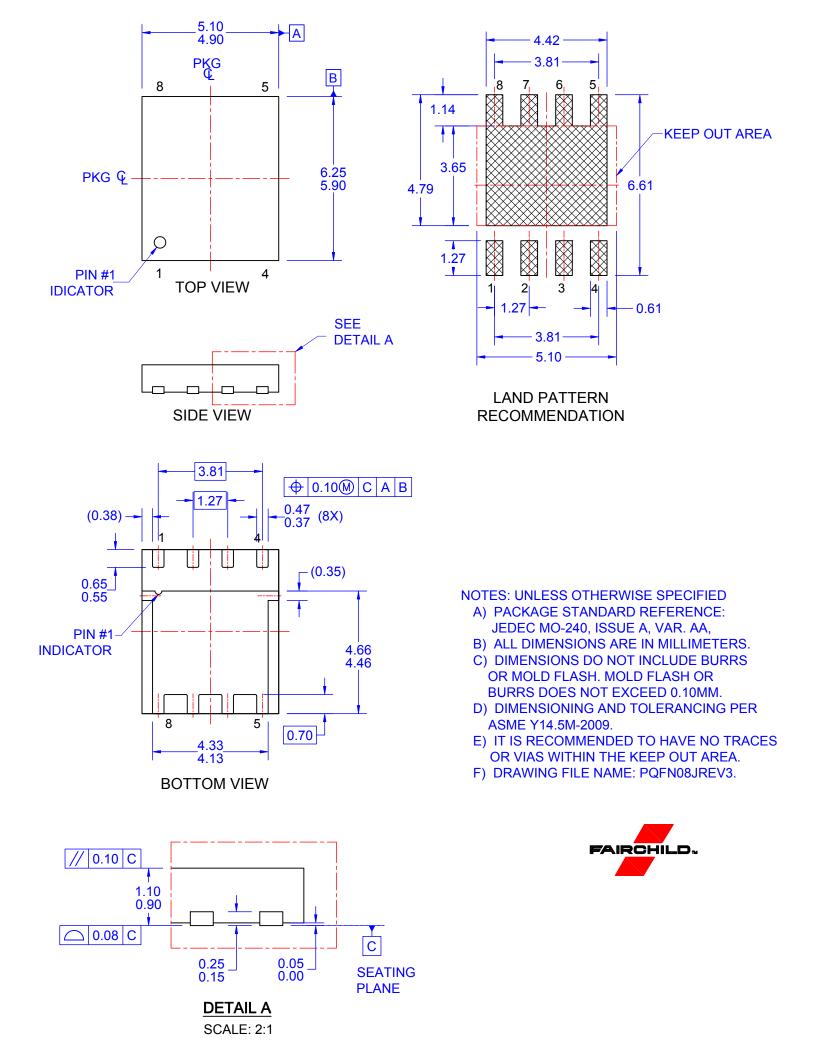
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FDMS86202 N-Channel Shielded Gate PowerTrench[®] MOSFET



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